

PATENT  
Attorney Docket No.: QUANT1190-3  
(028248-1010)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Dershem, et. al.

**Title:** THERMOSETTING RESIN  
COMPOSITIONS CONTAINING  
MALEIMIDE AND/OR VINYL  
COMPOUNDS

Appl. No.:    Unassigned

**Filing  
Date:**

Examiner: Unassigned

Art Unit: Unassigned

Commissioner for Patents  
Washington, D.C. 20231

## **PRELIMINARY AMENDMENT**

Sir:

This Preliminary Amendment is being filed prior to examination of the above-identified Continuing Prosecution Application. Prior to examination of the above-identified application, please consider the following amendments and remarks.

## IN THE CLAIMS

Please add new claims 46-48 and cancel claims 1-45.

46. A die-attach composition comprising a maleimide-containing curable component, wherein said composition is capable of curing at a temperature of less than about 200°C in a period of time of about 0.25 minutes up to about 2 minutes.